



Field Validation of Sub-Micron Defect Correlation with ≥ 1 Micron Particle Behavior in Undiluted POU CMP Slurry

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Outline

- ▶ Groundrules
- ▶ Production Conditions
- ▶ Principles Confirmed

Groundrules

- ▶ ICPT 2014 paper accepted
 - Joint publication: IM Flash Technologies & Vantage
 - Fab management has approved release
 - Details of fab correlation data will be presented in November

- ▶ Metadata: data about data
 - The lessons learned from this customer fab experience, combined with others, are the subject of this presentation

SlurryScope Experimental Setup

▶ Slurry Information

- Ceria based slurry
- 1-5% solids at point of use dilution
- Median particle size: ~ 150 nm
- Slurry flow rate target: 15 ± 1 mL/min

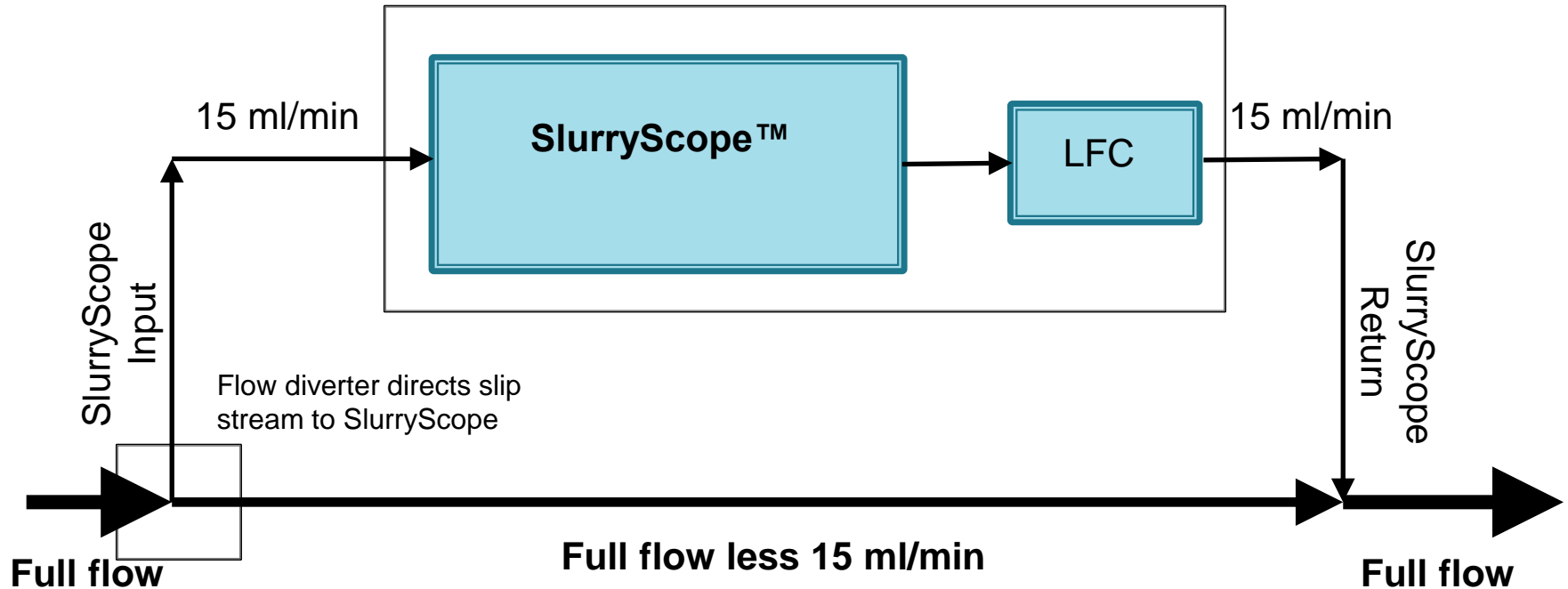
▶ Phase 1

- SlurryScope placed under the platen
- Sample taken at slurry input to the polisher before the POU filter
- Data collection triggered by the pneumatic signal used to open slurry valve supplying the polisher
- ~1 minute data collection with **1 second accumulation interval**
- Stop data collection when slurry flow drops below 14 mL/min

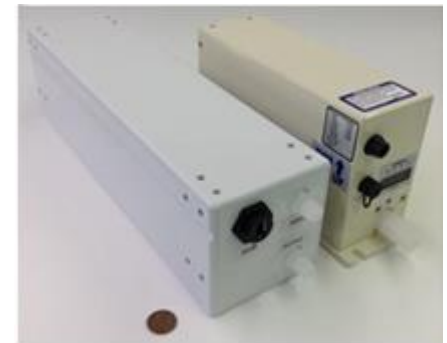
▶ Phase 2

- Sample taken in the CMP tool chase
- Continuous data collection with **10 second accumulation interval**

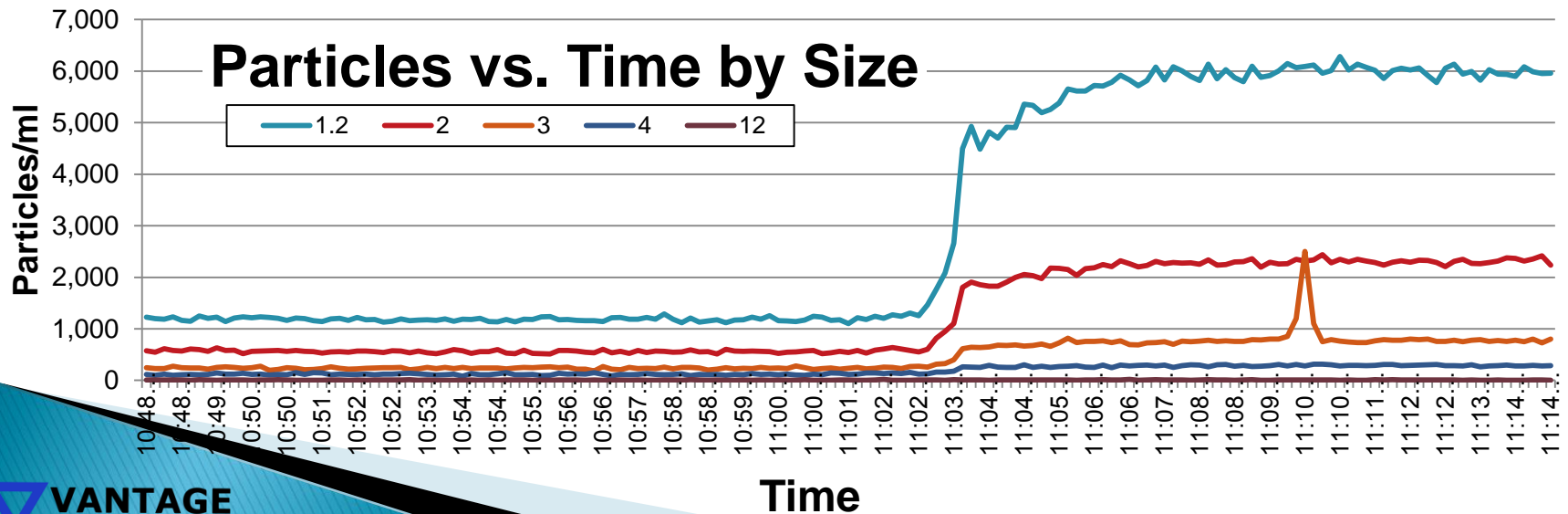
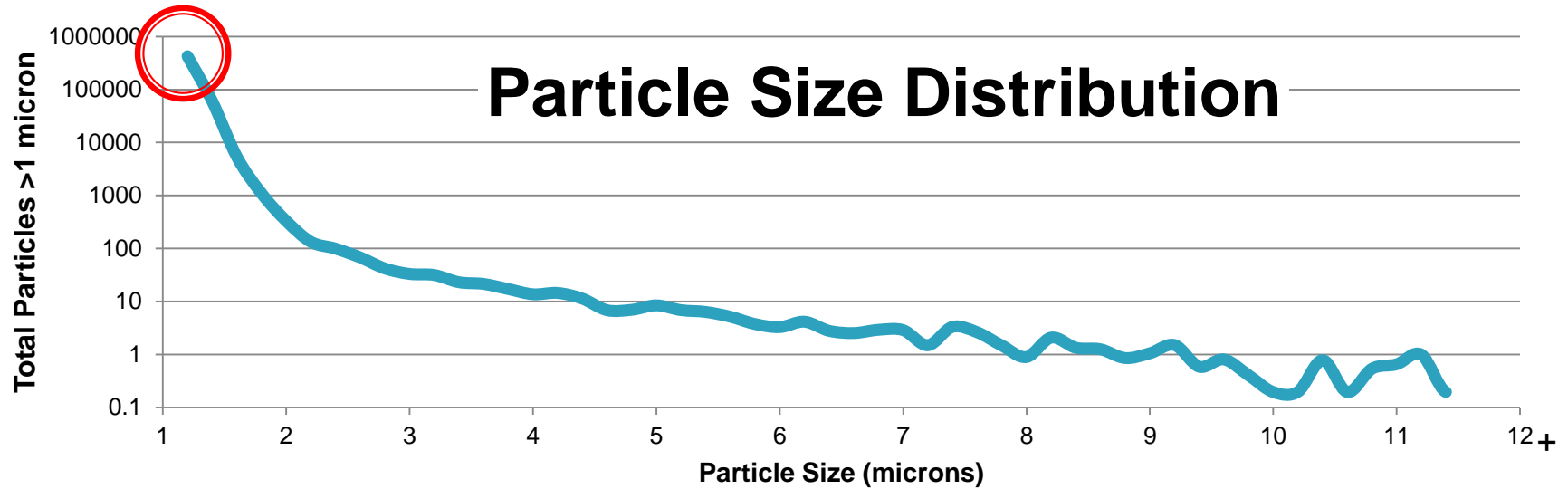
Vantage SlurryScope™ LPC Monitor



- ▶ Continuous, real-time measurement @ 15 ml/min
- ▶ Detection range 1 - 10+ μm in 0.2 μm increments or 0.8 - 4+ μm in 0.1 μm increments
- ▶ Undiluted POU CMP slurry



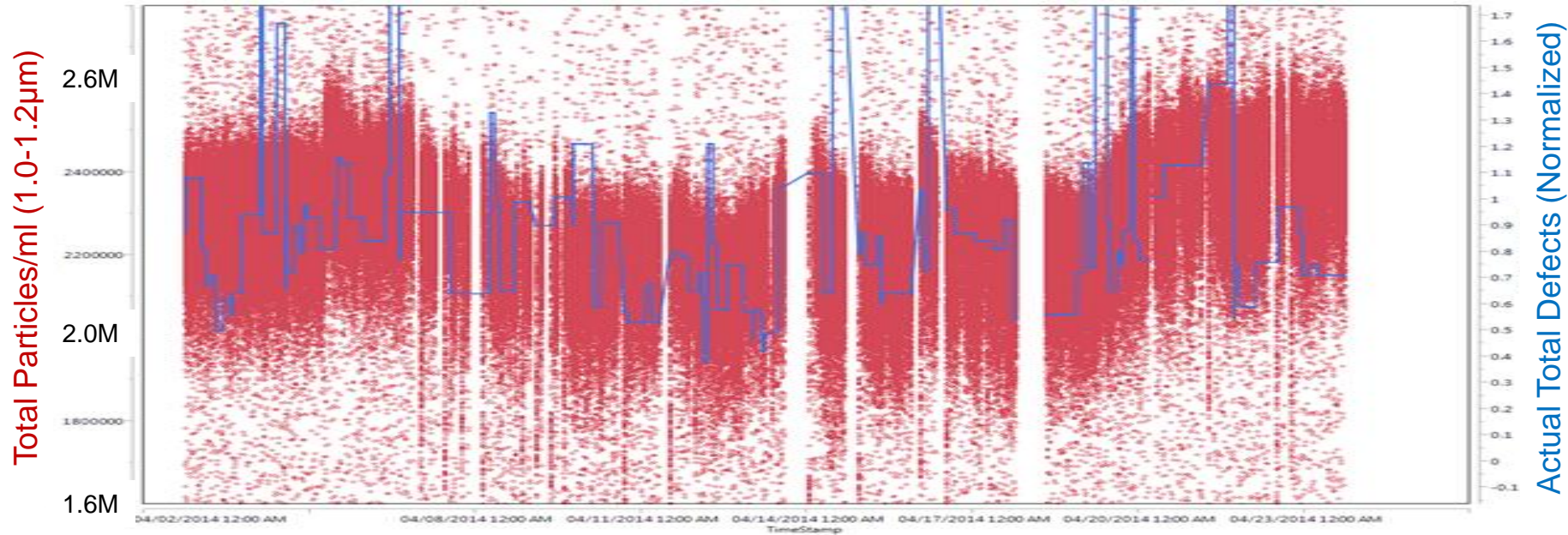
SlurryScope Data Modes



Principle #1 Confirmed

- ▶ Particle counts in the 1.0-1.2 μm size bin are a good proxy for what is happening in the majority sub-micron particle size distribution
 - For systemic slurry issues, large particles track the behavior of sub-micron particles
 - Continuous, real-time measurement of particles $>0.8\mu\text{m}$ in undiluted slurry is well demonstrated by SlurryScope
 - Continuous, real-time measurement $<0.8\mu\text{m}$ by any method remains an unsolved technical challenge

Current Customer Data - Preview



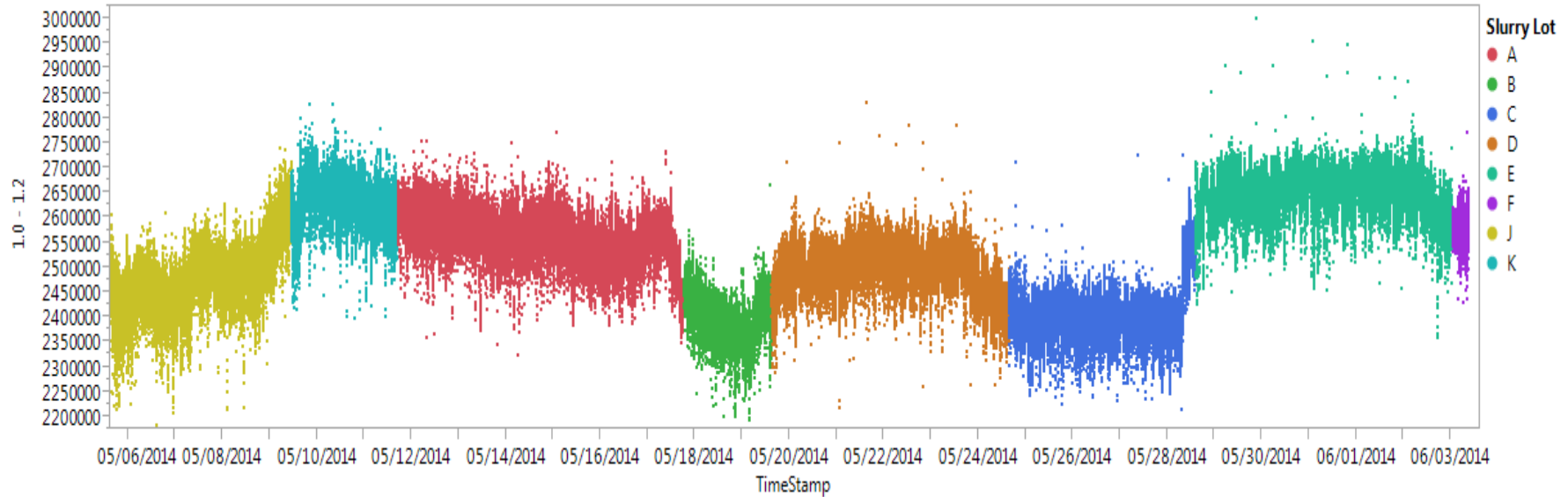
- ▶ Expanded LPC vertical scale (particles / mL)
- ▶ Normalized total defect data
- ▶ 3 weeks of data
- ▶ Blank spaces in data when not polishing

Principle #2 Confirmed

- ▶ There is signal in the noise
 - Small variations in stable LPC are the data that correlates with defects
 - Correlations that can be established over extended periods (several days, weeks) may be *undetectable* over shorter periods (hours, few days)
- ▶ Offline dilution particle data are noisy
 - Small sample size, infrequent measurements
 - Correlation to SlurryScope can be established over extended periods

Phase 2 SlurryScope Data

Bivariate Fit of 1.0 - 1.2 By TimeStamp



Raw Data

- ▶ Reduced noise in measurements
 - Longer accumulation interval (10 sec vs 1 sec)
 - Continuous flow of slurry rather than start/stop with slurry dispense on wafer
- ▶ Data shows variation as each new slurry lot begins to mix into slurry loop

Principle #3 Confirmed

- ▶ Batch-to-batch and tote-to-tote LPC differences comprise a significant driver for defect trends
 - Customers are asking slurry vendors to adapt methods and report SlurryScope data for QC
- ▶ LPC excursion events are *not* the defect driver in a stable SDS operation
 - Excursions are operational, largely self-inflicted
 - Identify the root cause and *STOP DOING THAT*
 - Defects *may be* caused by LPC excursions, but these are a ***separate population*** from the defects caused by systemic slurry changes

Principle #4 Confirmed

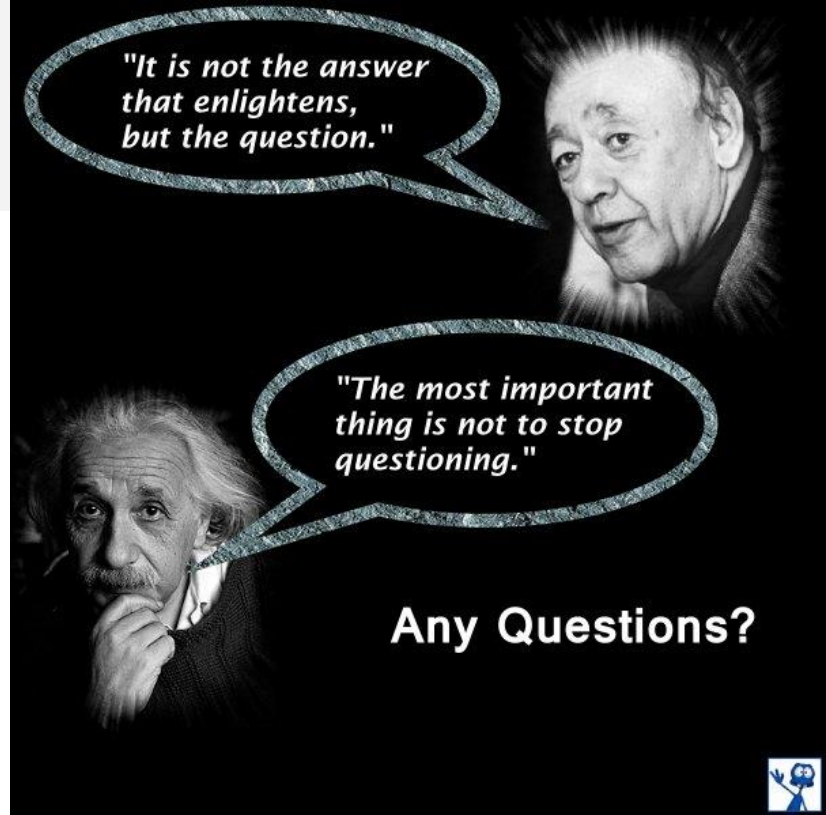
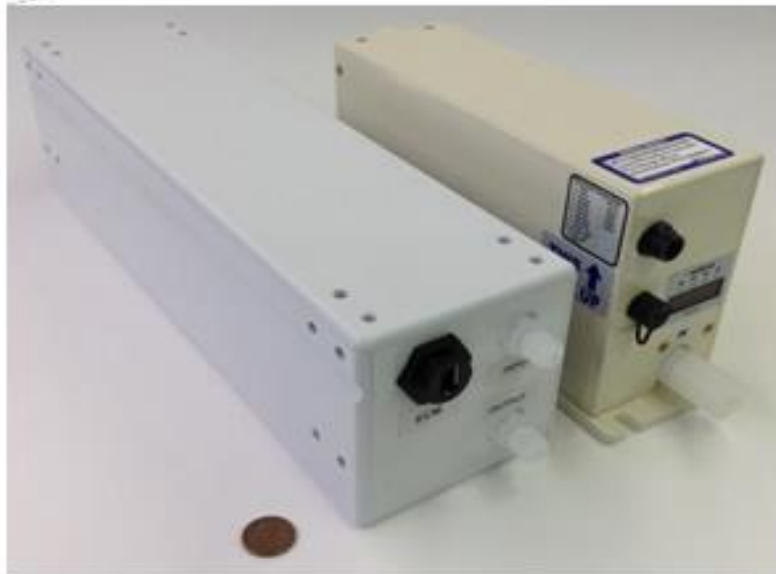
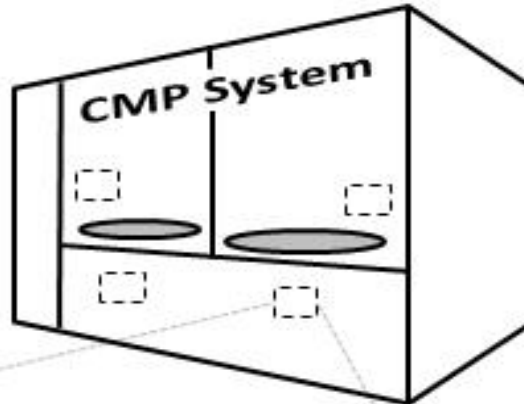
- ▶ The particles removed by filtration are not necessarily those that cause defects
 - SlurryScope measured $\geq 1.0\mu\text{m}$
 - SlurryScope sampling was *before* the POU filter
 - *After measurement*, slurry passed through POU filter onto the polishing platen
 - *This is the SlurryScope data that correlates with defects*
- ▶ **Say it again:** LPC data for particles $\geq 1.0\mu\text{m}$ is a good proxy for monitoring behavior of the sub-micron majority

Principle #5 Confirmed

- ▶ The smallest particle size bin carries systemic slurry information
 - Correlates with defects
 - Slurry tote and lot changes
 - Slurry pot aging
- ▶ Larger particle size bin data can be used to concurrently monitor operational events
 - Day tank changes
 - Filter changes
 - Pump changes

Final Thoughts

- ▶ One engineer was responsible for fab process operations and sub-fab slurry management
 - No “Upstairs Downstairs” contention
- ▶ The statistical data analysis methods used must be as sophisticated as the data itself
 - Simplistic number crunching can be easily overwhelmed by normal noise levels in the data
- ▶ Once SlurryScope data behavior is characterized in retrospect, methods can be developed for better managing fab operations and reducing defects



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